

# SCE600N1200MA3

1200V, 600A, 2.7mΩ, Half-Bridge, Silicon Carbide MOSFET Module



Product Data Sheet

ASTC-3T03-67A A/0

## General Description

The SCE-MA3 module incorporates AST's 1200V Gen3 N-channel SiC MOSFET.

## Features

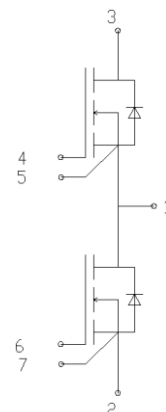
- Industry Standard 62mm Footprint
- Ultra Low Loss, High-frequency Operation
- Zero Reverse Recovery from Diodes
- Zero Turn-off Tail Current from MOSFET
- Normally-off, Fail-safe Device Operation
- Copper Baseplate and Silicon Nitride Insulator

## Applications

- High Frequency Switching Application
- DC/DC Converter
- Solar and Wind Inverters
- UPS and SMPS
- Traction

## Key Parameters

Symbol	Parameter	Values			Unit	Test Conditions
<b>Absolute maximum rating</b>						
$V_{DS}$	Drain-source Voltage	1200			V	$T_C=25^\circ\text{C}$
$I_D$	Drain Current (continuous)	600			A	$T_C=25^\circ\text{C}$
$T_J$	Junction Temperature	175			$^\circ\text{C}$	
Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
<b>Static characteristics</b>						
$R_{DS(on)}$	Static Drain-source on Resistance	-	2.7	3.7	mΩ	$V_{GS}=18\text{V}; I_D=300\text{A}; T_C=25^\circ\text{C}$
<b>Dynamic characteristics</b>						
$Q_G$	Total Gate Charge	-	1428	-	nC	$V_{DD}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A}; T_C=25^\circ\text{C}$
$Q_{GD}$	Gate-drain Charge	-	469	-		
<b>Source-drain diode</b>						
$Q_{RR}$	Reverse Recovery Charge	-	3678	-	nC	$V_{GS}=-5/+18\text{V}; I_F=300\text{A}; V_R=800\text{V}; \text{Load}=100\mu\text{H}; T_J=25^\circ\text{C}$



## Ordering Informations

Order Number / Marking	SCE600N1200MA3
Package Type	ME3

Absolute Maximum Ratings (at  $T_c=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Values	Unit
$V_{DS}$	Drain-source Voltage	1200	V
$V_{GS}$	Gate-source Voltage (dynamic)	-10/+22	V
$I_D$	Drain Current (continuous)	600	A
$I_{DM}$	Drain Current (pulsed)	1200	A
$T_{op}; T_{stg}$	Operating and Storage Temperature Range	-40 to +150	$^\circ\text{C}$
$T_J$	Junction Temperature	175	$^\circ\text{C}$
$R_{th Jh}$	Thermal Resistance, Junction-to-heatsink	0.12	$^\circ\text{C}/\text{W}$

## MOSFET Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
<b>Static characteristics (at <math>T_c=25^\circ\text{C}</math> unless otherwise specified)</b>						
$BV_{DS}$	Drain-source Breakdown Voltage	1200	-	-	V	$V_{GS}=0\text{V}$
$I_{DSS}$	Zero Gate Voltage Drain Current	-	-	300	$\mu\text{A}$	$V_{DS}=1200\text{V}; V_{GS}=0\text{V}$
$I_{GSS}$	Gate-body Leakage Current	-	-	3.0	$\mu\text{A}$	$V_{GS}=-10/20\text{V}; V_{DS}=0\text{V}$
$V_{GS(th)}$	Gate Threshold Voltage	2.0	-	4.0	V	$V_{DS}=V_{GS}; I_D=60\text{mA}$
$R_{DS(on)}$	Static Drain-source on Resistance	-	2.7	3.7	$\text{m}\Omega$	$V_{GS}=18\text{V}; I_D=300\text{A}$
$V_{GS(on)}$	Recommended Turn-on Voltage	-	18	-	V	Static
$V_{GS(off)}$	Recommended Turn-off Voltage	-	-5	-	V	
$R_G$	Gate Resistance	-	0.5	-	$\Omega$	$V_{GS}=0\text{V}; f=1\text{MHz}$
<b>Dynamic characteristics (at <math>T_c=25^\circ\text{C}</math> unless otherwise specified)</b>						
$C_{iss}$	Input Capacitance	-	41.3	-	nF	$V_{DS}=800\text{V}; f=1\text{MHz}; V_{AC}=25\text{mV}$
$C_{oss}$	Output Capacitance	-	1.7	-		
$C_{rss}$	Reverse Transfer Capacitance	-	78	-	pF	
$E_{on}$	Turn-on Switching Energy	-	24.6	-	mJ	$V_{DS}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A};$ $\text{Load}=100\mu\text{H}$
$E_{off}$	Turn-off Switching Energy	-	19.2	-		
$Q_{GS}$	Gate-source Charge	-	460	-	nC	$V_{DD}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A}$
$Q_{GD}$	Gate-drain Charge	-	469	-		
$Q_G$	Total Gate Charge	-	1428	-		
$t_{d(on)}$	Turn-on Delay Time	-	103	-	ns	$V_{DD}=800\text{V}; V_{GS}=-5/+18\text{V}; I_D=300\text{A};$ $R_{G(ext)}=5.0\Omega; \text{Load}=100\mu\text{H}$
$t_r$	Rise Time	-	92	-		
$t_{d(off)}$	Turn-off Delay Time	-	448	-		
$t_f$	Fall Time	-	76	-		

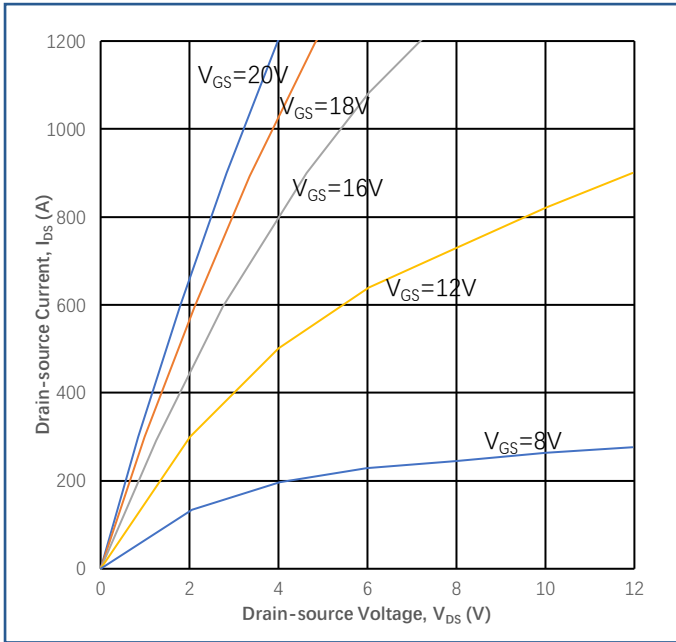
## Body Diode Characteristics (at $T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$V_{FSD}$	Forward Voltage	-	-	6	V	$V_{GS}=0\text{V}; I_F=300\text{A}$
$I_S$	Continuous Diode Forward Current	-	300	-	A	$V_{GS}=0\text{V}; T_C=25^\circ\text{C}$
$t_{RR}$	Reverse Recovery Time	-	89	-	ns	$V_{GS}=-5/+18\text{V}; I_F=300\text{A};$ $V_R=800\text{V}; \text{Load}=100\mu\text{H}$
$Q_{RR}$	Reverse Recovery Charge	-	3678	-	nC	
$I_{RRM}$	Peak Reverse Recovery Current	-	133	-	A	

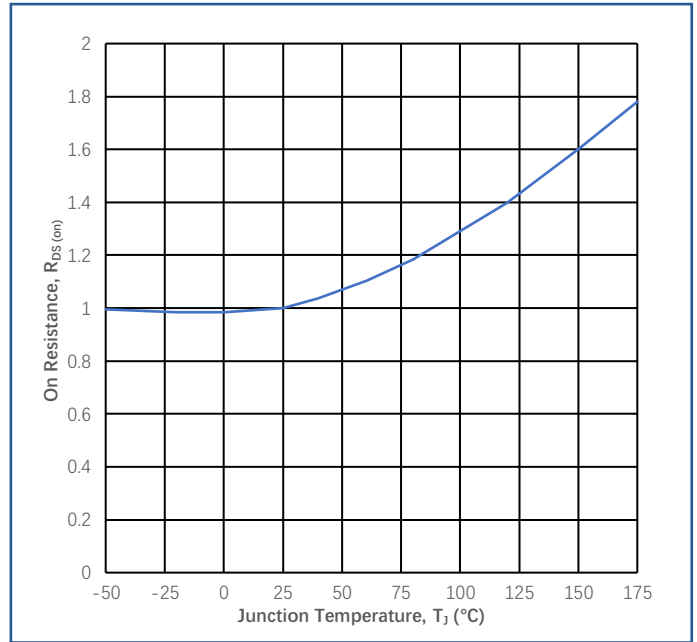
## Module Physical Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
$L_{Stray}$	Stray Inductance	-	20	-	nH	
$W$	Weight	-	340	-	g	
$M_S$	Mounting Torque	4.0	-	5.5	Nm	M6-1.0 Bolts
$V_{isol}$	Case Isolation Voltage (DC; $t=1\text{min}$ )	4.2	-	-	kV	
-	Clearance Distance	-	11	-	mm	Terminal to Terminal
		-	23	-	mm	Terminal to Baseplate
-	Creepage Distance	-	23	-	mm	Terminal to Terminal
		-	29	-	mm	Terminal to Baseplate

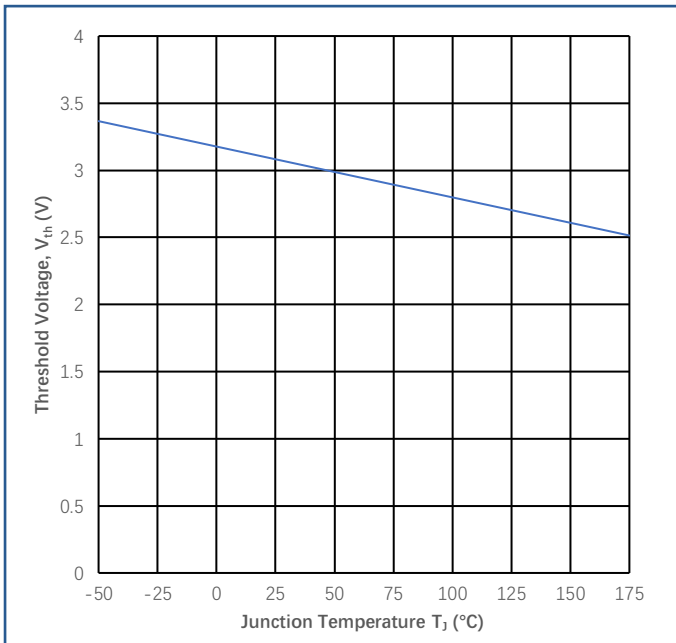
**Typical Performance**



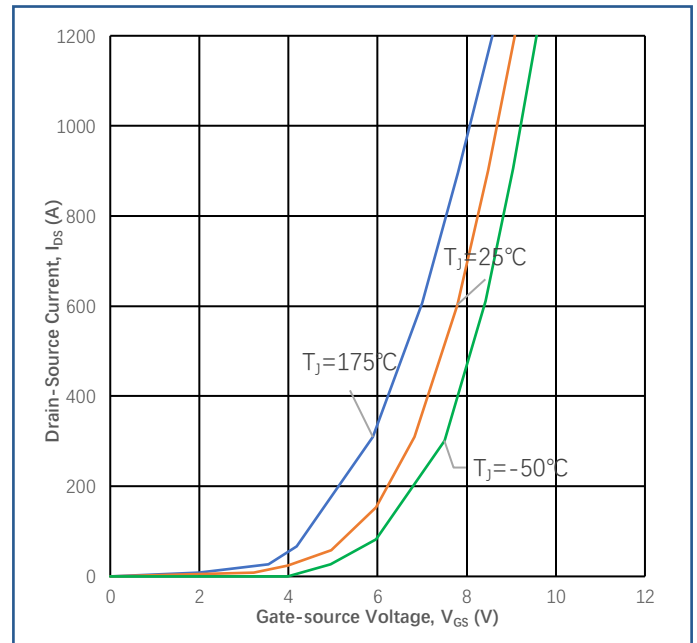
**Figure 1**  
Output Characteristics ( $T_J=25\text{ }^\circ\text{C}$ )



**Figure 2**  
Normalized On-resistance vs. Temperature

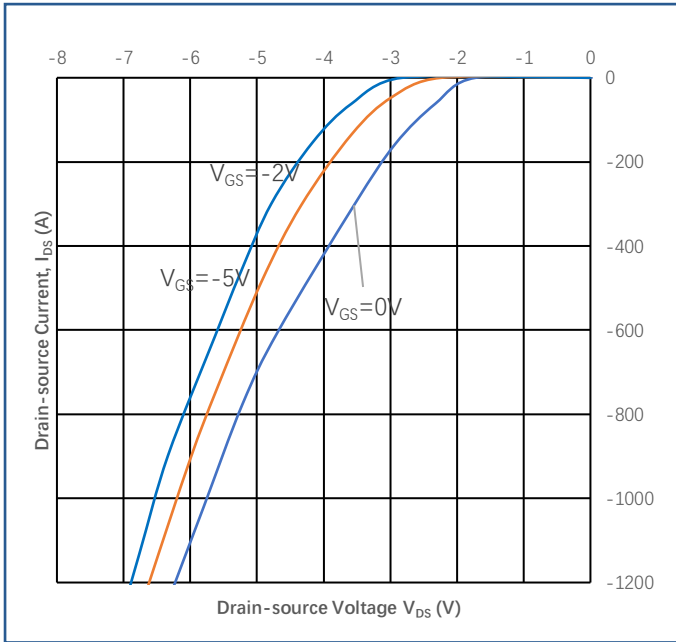


**Figure 3**  
Threshold Voltage vs. Temperature

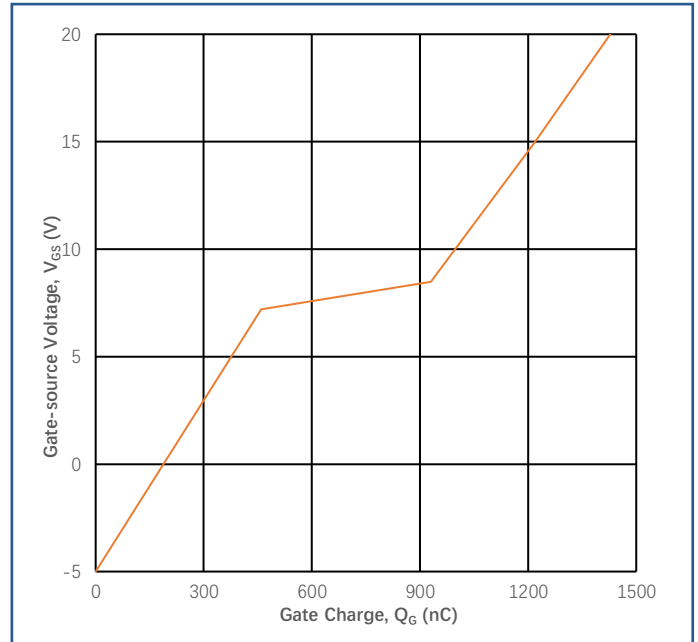


**Figure 4**  
Transfer Characteristic for Various  $T_J$ ,  $V_{DS}=20\text{V}$

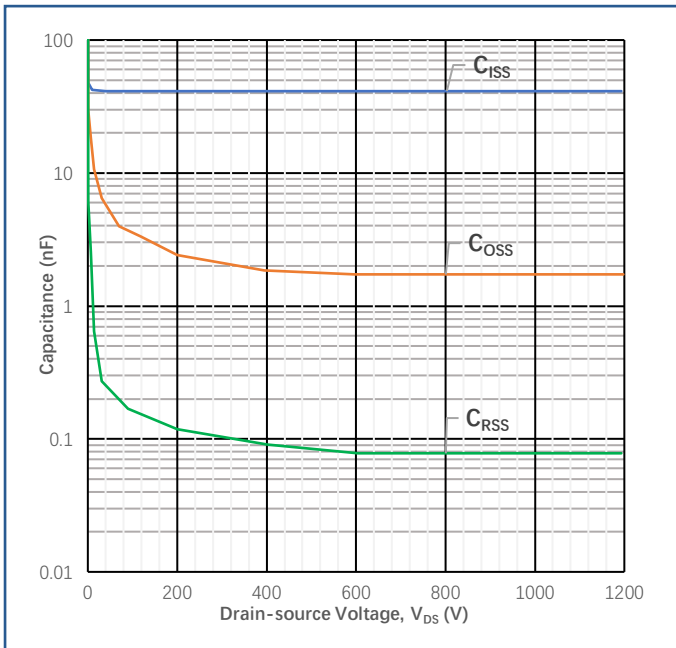
**Typical Performance**



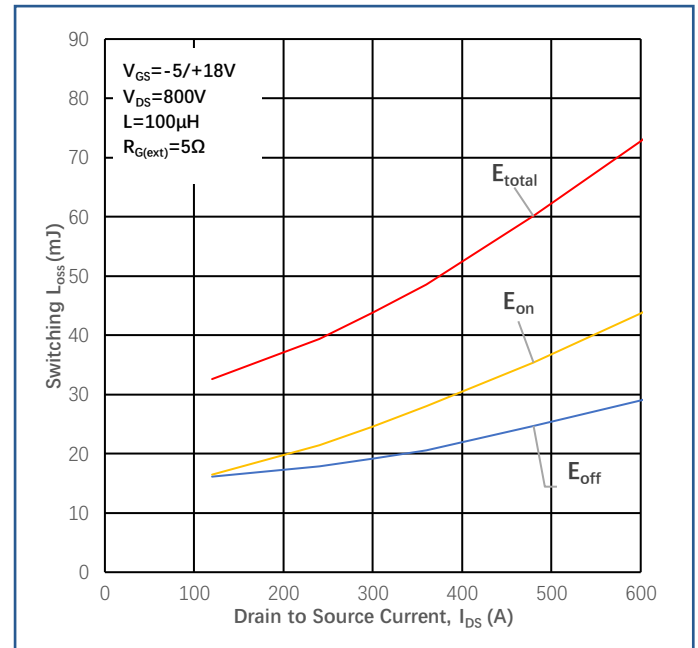
**Figure 5**  
Diode Characteristic at 25 °C



**Figure 6**  
Typical Gate Charge Characteristics

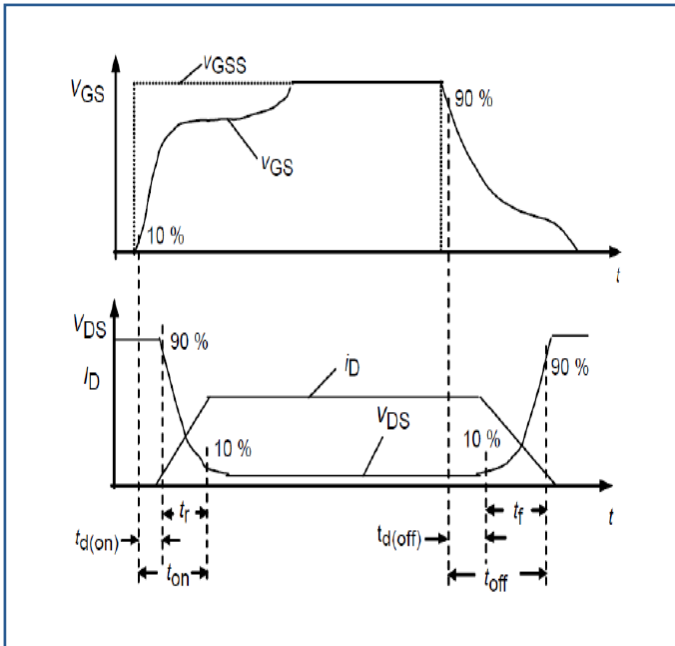


**Figure 7**  
Typical Capacitances vs. Drain-source Voltage

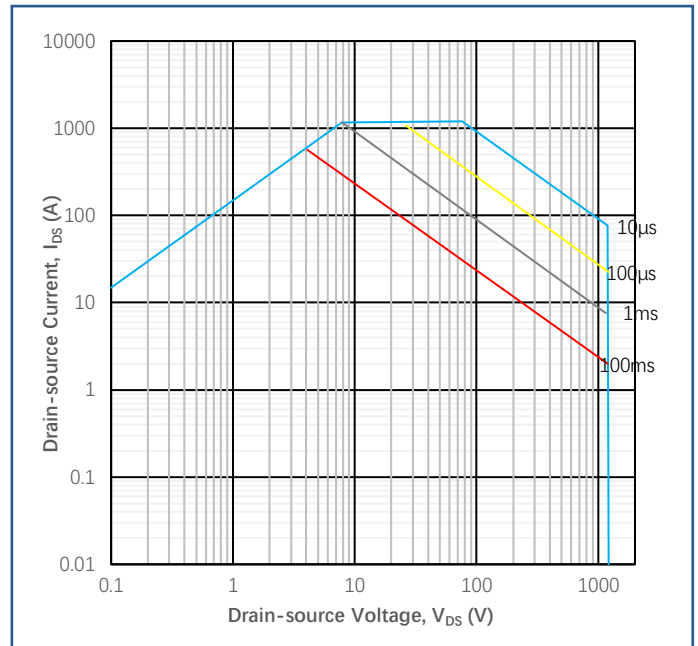


**Figure 8**  
Inductive Switching Energy vs. Drain Current

**Typical Performance**

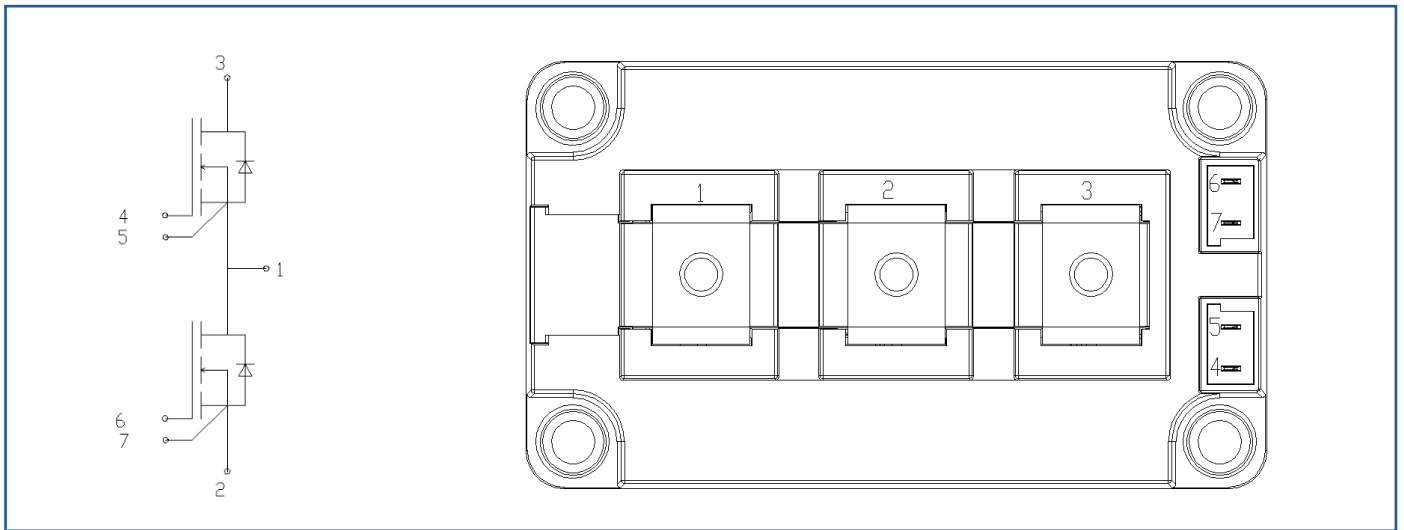


**Figure 9**  
Switching Time Description

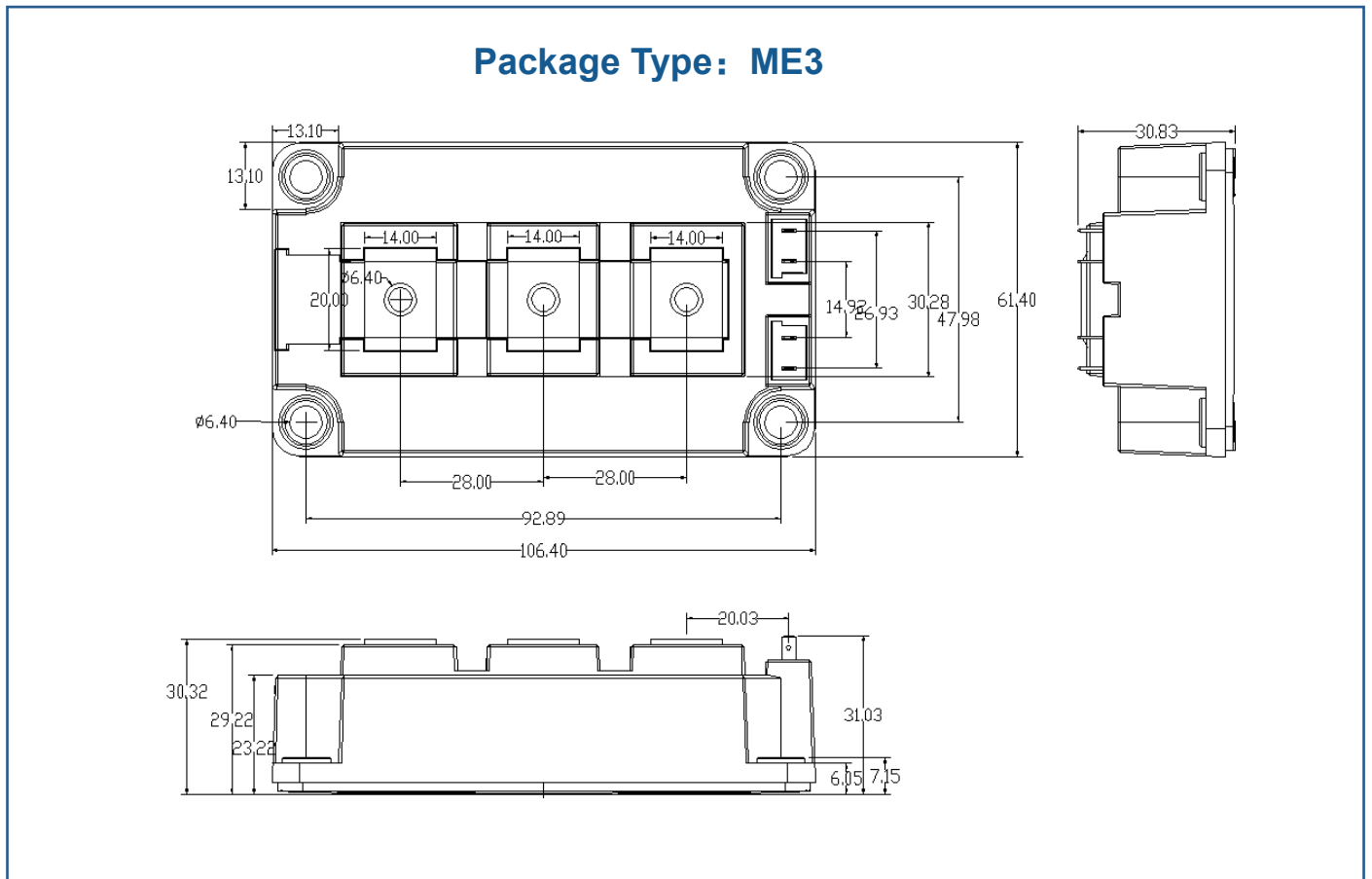


**Figure 10**  
Safe Operating Area

### Circuit Diagram Headline



### Package Dimensions (mm)



未标注线性公差按 GB/1804-2000c 级执行	公差分段	0.5-3	3-6	6-30	30-120	120-400
	c 级	±0.2	±0.3	±0.5	±0.8	±1.2

## Notes & Disclaimer

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